MOTOROLA SEMICONDUCTOR TECHNICAL DATA

Datasheet

Automotive H-Bridge Driver

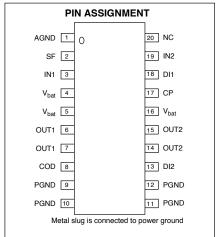
- · Operating Supply Voltage 5V to 28V
- · Overvoltage Protection against Transients up to 40V at Vbat
- RDSon = $150m\Omega$ for each Output Transistor at 25° C
- Continous DC Load Current 5A (TC < 100°C)
- Output Current Limitation at typ 6,5A +/- 20%
- · Short-Circuit Shutdown for Output Currents over 8A
- · Logic Inputs TTL/CMOS Compatible
- Operating Frequency up to 20 kHz
- Overtemperature Protection
- · Short-Circuit Protection
- · Undervoltage Disable Function
- · Diagnostic Output
- 2 Disable Inputs
- · Coding Input for Alternative Functions
- HSOP20 Power Package
- Stable Operation with an External Capacitance of maximum
- 47μF at Vbat

MC33186

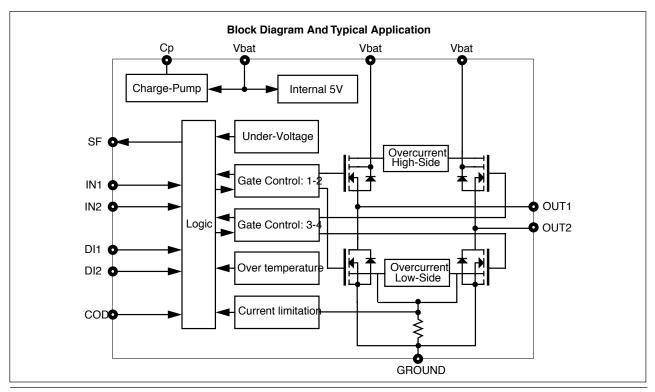
Automotive H-Bridge Driver

SILICON MONOLITHIC INTEGRATED CIRCUIT





ORDERING INFORMATION					
Device	Temperature Range	Package			
MC33186DH1	-40°C to +125°C	HSOP20			



MAXIMUM RATINGS

Ratings	Symbol	Min	Тур	Max	Unit
ELECTRICAL RATINGS		1		•	
Supply Voltage - Static Destruction Proof - Dynamic Destruction Proof t < 0,5s	Vbat Vbat	- 1 - 2		28 40	V
Logic Inputs (IN1, IN2, DI1, DI2, CODE)	U	- 0.5		7	V
Output Status - Flag SF	U _{SF}	- 0.5		7	V
THERMAL RATINGS		•			
Junction Temperature	Tj	- 40		+150	°C
Storage Temperature	T _s	- 55		+125	°C
Ambient Temperature	T _a	- 40		+125	°C
Thermal Resistance (with power applied on 2 power MOS)	Rth _{JC}			+1,5	K/W

ELECTRICAL CHARACTERISTICS.Tj: from -40°C to +150 °C, Vbat from 5 V to 28 V, unless otherwise note. Typical values reflect approximate mean at 25°C, nominal VCC, at time of device characterization.

Characteristics	Symbol	Min	Тур	Max	Unit
RANGE OF VALIDITY					
	Vbat T _j	5 -40		28 150	°C V
POWER SUPPLY	,	•			
Operating Range : - Static - Dynamic (t < 500ms)	Vbat Vbat	5		28 40	V V
Stanby current - f = 0 to 10KHz ; I _{OUT} = 0A	l Vbat			35	mA
Vbat-undervoltage switch-off (without load) - Switch-off Voltage - Switch-on Voltage - Hysteresis		4.15 4.5 150	4.4 4.75	4.65 5	V V mV
CHARGE-PUMP SUPPLY			T		
- Vbat = 4.15 V- Vbat < 40V	Vcp - Vbat Vcp - Vbat	3.35		20	V V
LOGIC INPUTS				,	
Input High	VinH	3.4			V
Input Low	VinL			1.4	V
Input Hysteresis	U	0.7	1		V
Input Current (IN1, IN2, DI1) - U _{IN} = 0V	I	- 200	- 80		μΑ
Input Current (DI2,COD) - U _{DI2} = 5V	I _{DI2}		25	100	μΑ

ELECTRICAL CHARACTERISTICS.Tj: from -40°C to +150 °C, Vbat from 5 V to 28 V, unless otherwise note. Typical values reflect approximate mean at 25°C, nominal VCC, at time of device characterization.

Characteristics	Symbol	Min	Тур	Max	Unit
POWER OUTPUTS : OUT1, OUT2		-			
Switch on resistances : Rout - Vbat ; Rout - GND					
- Vbat =5 to 28V ; Ccp = 0 to 33nF				300	mΩ
Current Limitation Controlled Peak Value		•			
Switch-off Current	(I _{OUT}) max	5.2	6.5	7.8	А
Switch-off Time	ta	15	20.5	26	μS
Blanking Time	tb	12	16.5	21	μS
High Side Overcurrent Detection Low Side Overcurrent Detection (4)	I _{OCHS}	11 8			A A
Leackage Current - Output Stage Switched off				100	μΑ
Free-Wheeling Diode Forward Voltage - I _{OU} = 3A	U _D			2	V
Free-Wheeling Diode Reverse Recovery Time	trr	100			ns
- Switch-off Temperature - Hysteresis		160 20		190 30	°C
OUTPUT STATUS FLAG (Open drain output)		1	1		
Output High (SF not set) U _{SF} = 5V	I _{SF}			10	μΑ
Output Low (SF set) ISF = 300 μA	VSF			1	V
TIMING		•			
PWM frequency - C _{CP} = 33nF	f			10	KHz
Maximum Switching Frequency During Current Limitation - Vbat = 628VC _{CP} = 33nF	f			20	KHz
Output ON Delay IN1>OUT1 or IN2>OUT2	t _{don}			15	μs
Output OFF Delay IN1>OUT1 or IN2>OUT2	t _{doff}			15	μs
Output Switching Time - C _{CP} = 0 to 33nF OUTiHOUTiL, OUTILOUTiH, IOUT= 3A	t _r , t _f	2		5	μs
Disable Delay Time DliOUTi	t _{ddis}			8	μs
Turn off in Case of Over-current or Over-temperature			4		μs
Power On Delay Time (Ccp = 33nF)			1	5	ms

TRUH TABLE

Device State	Input Conditions		Status		Outputs			
	DI1 (3)	DI2 (3)	IN1	IN2	SF (5)	SF (6)	OU1	OU2
1-Forward	L	Н	Н	L	Н	Н	Н	L
2-Reverse	L	Н	L	Н	Н	Н	L	Н
3-Free Wheeling Low	L	Н	L	L	Н	Н	L	L
4-Free Wheeling High	L	Н	Н	Н	Н	Н	Н	Н
5-Disable 1	Н	Х	Х	Х	L	Н	Z	Z
6-Disable 2	Х	L	Х	Х	L	Н	Z	Z
7-IN1 Disconnected	L	Н	Z	Х	Н	Н	Н	х
8-IN2 Disconnected	L	Н	Х	Z	Н	Н	x	Н
9-DI1 Disconnected	Z	Х	Х	Х	L	Н	Z	Z
10-DI2 Disconnected	Х	Z	Х	Х	L	Н	Z	Z
11-Current Limit.active	L	Н	х	х	Н	Н	Z	Z
12-Undervoltage (1)	Х	Х	Х	Х	L	L	Z	Z
13-Over-temperature (2)	х	х	х	х	L	L	Z	Z
14-Over-current (2)	х	Х	Х	х	L	L	Z	Z

NOTE:

(5) COD=nc or GND (6) COD = VCC

L = Low

Z = High or Low
Z = High impedance (all output stage transistors are switched off).

NOTE:

(1) In case of undervoltage, tristate and status-flag are reset automatically.
(2) Whenever over-current or over-temperature is detected, the fault is stored (i.e. status-flag remains low).
The tristate conditions and the status-flag are reset via D11 (IN1) or DI2 (IN2).
Pinnames in brackets refer to coding pin (COD=Vcc).
(3) If COD = Vcc then D11 and D12 are not active.
(4) In case of over-current, the time when the current is greater than 7,8A is lower than 30µs, with a maximum frequency of 1kHz.

MC33186

PINS FUNCTION DESCRIPTION

Pin	Name	Description	
1, 9, 10,11,12 Metal slug	GND	Power Ground	
1	GND	Analog ground	
2	Output Status- flag (SF)	Open drain output, active low. Is set according to the truth table .	
3,13 18, 19	Inputs IN1,IN2 DI1,DI2, COD	Voltage controlled inputs with hysteresis	
8	COD	When not connected or connected to GND, a stored failure will be reset by change of the voltage-level on DI1 or DI2. When connected to Vcc, the disable pin DI1 and DI2 are inactive. A stored failure will be reset by change of the voltage-level on IN1 or IN2.	
6, 7, 14, 15	OUT1 , OUT2	H-Bridge outputs with integrated free-wheeling diodes.	
4, 5, 16	Vbat	a) Supply voltage supervision The supply voltage is supervised . If it is below its specific threshold , the power stages are switched in tristate and the status flag is switched low. If the supply voltage is over the specific theshold again , the power stage switches independently into normal operation, according to the input pins and the status flag is reset . b) Thermal supervision In case of over-temperature the power stages are switched in tristate independent of the inputs signals and the status flag is switched low. If the level changes from high to low on DI1 (IN1) or low to high on DI2 (IN2), the output stage switches on again if the temperature is below the specified limit .The statusflag is reset to high level (Pinnames in brackets refer to coding pin=Vcc). c) Supervision of overcurrent If overcurrent is detected the power stages are independent of the inputs signals switched in tristate and the status flag is set. If the level changes from high to low on DI1 (IN1) or low to high on DI2 (IN2) the output stage switches on again and the status flag is reset to high level (Pinnames in brackets refer to coding pin = Vcc). The output stage switches into the mode defined by the inputs pins provided the temperature is below the specified limits . d) Current limiting The maximum current which can flow under normal operating conditions is limited to Imax = 6,5A +/- 20%. When the maximum current value is reached, the output stages are switched tristate for a fixed time. According to the time constant the current decreases until the next switch on occurs. See page 8 for schematics.	

Ccp=33nF **47**μ**F** vcc VBat Voltage Regulator Power Ground СР - IN1 Microcontroller IN2 OUT1 (M)OUT2 Di2 COD GND

Figure 1. Typical Application

Figure 2. Output delay time

Power Ground

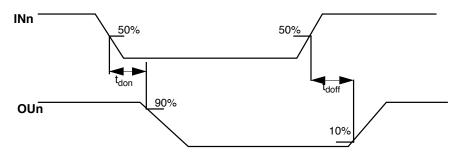


Figure 3. Disable Delay Time

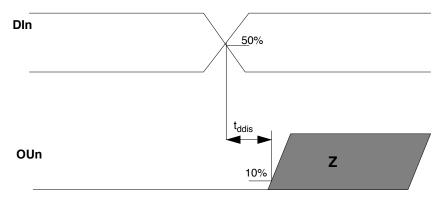


Figure 4. Output Switching Time

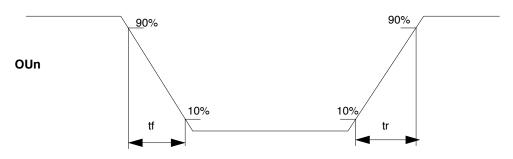


Figure 5. Current Limitation

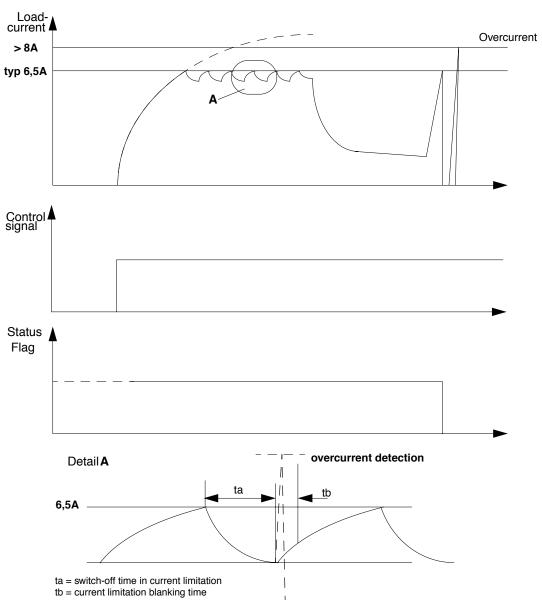


Figure 6 - Standby Current versus Temperature

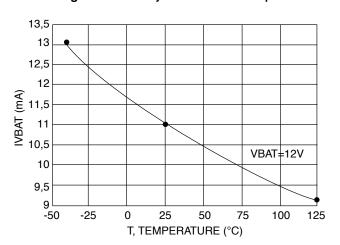


Figure 7. VBAT Undervoltage versus Temperature

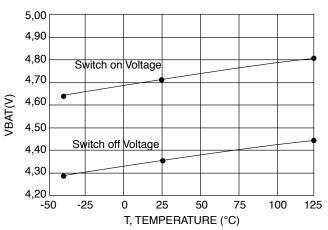


Figure 8 - LowThreshold Input Voltage versus Temperature

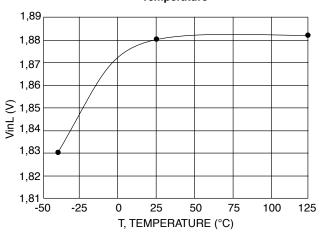


Figure 9 - High Threshold Input Voltage versus Temperature

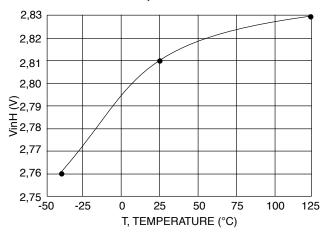


Figure 10 - Vcp versus Battery Voltage

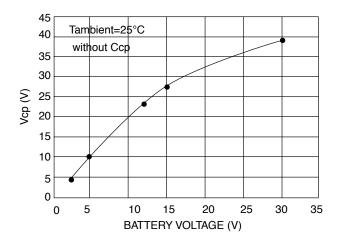


Figure 11. RDSON versus Temperature

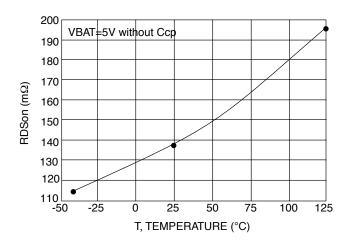


Figure 12. Switch off current versus Temperature

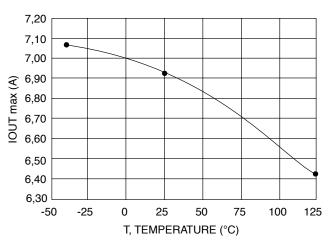


Figure 13. Over Current Detection versus Temperature

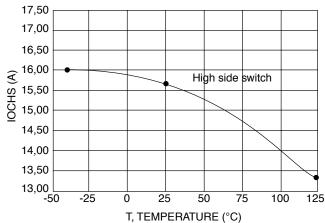


Figure 14. Current Limitation

Figure 15. Switch off Time

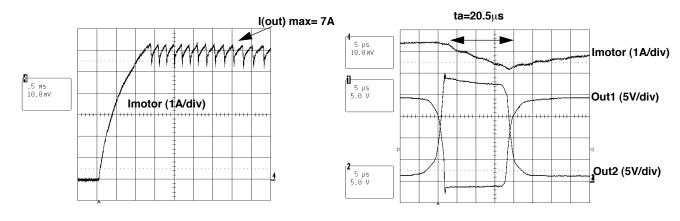


Figure 16. Output Switching Time: Tr

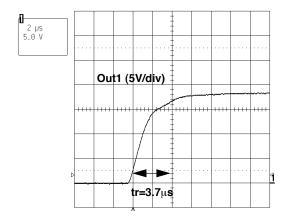


Figure 17. Output Switching Time: Tf

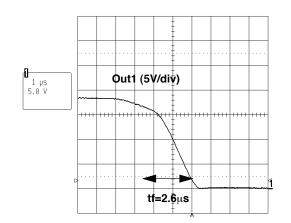


Figure 18. Output ON Delay

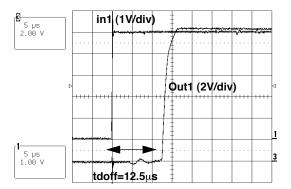


Figure 19. Output OFF Delay

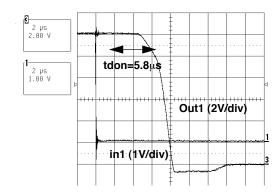


Figure 20. Disable Delay Time

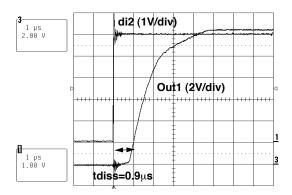
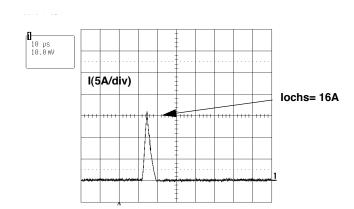


Figure 21. High side Overcurrent Detection



10

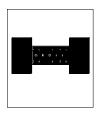
PACKAGE INFORMATION

The HSOP20 package is designed for enhanced thermal performance. The particularity of this package is its copper baseplate on which the power die is soldered. The baseplate is soldered on a PCB to provide heat flow to the ambient and also to provide a large thermal capacitance.

Of course, the more copper area on the PCB, the better the power dissipation and transient behaviour.

We characterized the HSOP20 on a double side PCB. The bottom side area of the copper is 7.8 cm². The top surface is 2.7 cm², see Figure 22.

Figure 22. PCB Test Layout





Top Side

Bottom Side

Figure 23. PHSOP20Thermal Response

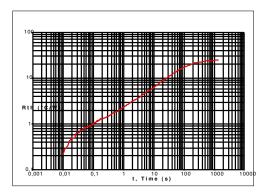
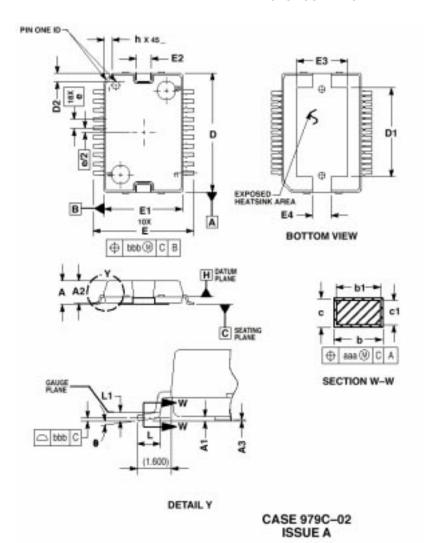


Figure 23 shows the thermal response with the device soldered on to the test PCB described on figure 22.

CASE OUTLINES



MOTES

- CONTROLLING DIMENSION: MILLMETER. DIMENSIONS AND TOLERANCES PER ASME
 - V14 584 1994
- Y11-98, 1994.
 DATUM PLANE -HH- BLDCATED AT BOTTOM OF LEAD AND IS CONCIDENT WITH THE LEAD WHERE THE LEAD EATS THE PLASTIC BODY AT THE BOTTOM OF THE PRATTING LIKE.
 DIMENSIONS DIAND ET DO MOT MICLIDE MOLD.
- PROTRISION, ALLOWABLE PROTRISION IS 0.150 PER SIDE, DIMENSIONS D AND E1 DO INCLIDE MCCUBIRMITCH AND ARE DETERMINED AT DATUM PLANE -H-DIMENSION IS DOES NOT INCLUDE DAMBAR
- PROTRUSION ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 TOTAL IN EXCESS OF THE 5 DIMENSION AT MAXIMUM MATERIAL
- CONSTIDAT

 DATUMS -A- AND -B- TO BE DETERMINED AT

 DATUM PLANE -B
 DIMEMSION D DOES NOT INCLUDE TIEBAR

 PROTRUSIONS ALLOWABLE TIEBAR

 PROTRUSIONS ARE 0.150 PER SIDE

	MILLIMETERS					
Dear	HIN	MAX				
A	3.000	3.400				
A1	0.100	0.300				
A2	2.900	3.100				
A3	0.90	0.100				
D	35.800	15.000				
Ø 1	11,700	12.600				
02	0.900	1,100				
E	13.950	14.450				
\$1.	10.900	11,100				
£2	2.500	2,700				
£3	6.400	7.200				
E4	2.700	2.900				
L	0.840	1.100				
1.1	0.350 BBC					
b .	0.400	0.520				
21	0.400	0.462				
¢	0.230	0.320				
61	0.230	0.280				
e	1.270 BSC					
h	_	1.100				
	0					
988	0.290					
bbb	0.100					

DATE 07/22/98

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